

OptoTEC™ OTX Series Thermoelectric Cooler

The OTX20-24-F2A-0709-GG-W2.25 is a high-performance, miniature thermoelectric cooler. The OTX20-24-F2A-0709-GG-W2.25 is primarily used in applications to stabilize the temperature of sensitive optical components in the telecom and photonics industries. It has a maximum Q_c of 3.4 Watts when $\Delta T = 0$ and a maximum ΔT of 72.9 °C at $Q_c = 0$.

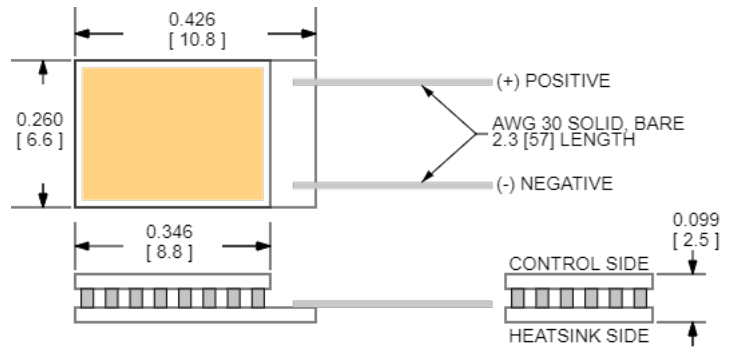


Features

- Miniature footprint
- Precise temperature control
- Reliable solid-state operation
- No sound or vibration
- RoHS-compliant

Applications

- [Laser Diodes](#)
- [Optical Transceivers](#)
- [Lidar Sensors](#)
- [Infrared Range \(IR\) Sensors](#)
- [CMOS Sensors](#)
- [Autonomous Systems](#)
- [Machine Vision](#)
- [Security Cameras](#)



CERAMIC MATERIAL: Al_2O_3

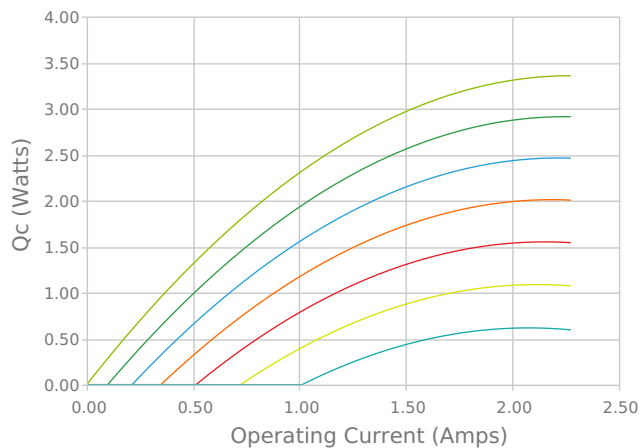
SOLDER CONSTRUCTION: 232°C, SbSn

INCHES [MM]

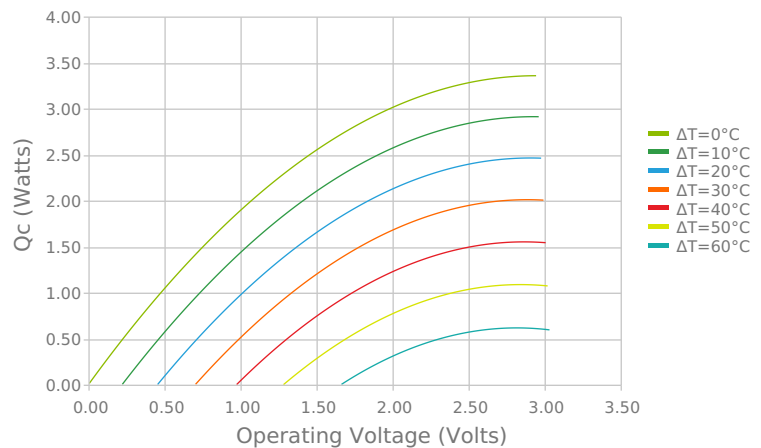
ELECTRICAL AND THERMAL PERFORMANCE

For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.

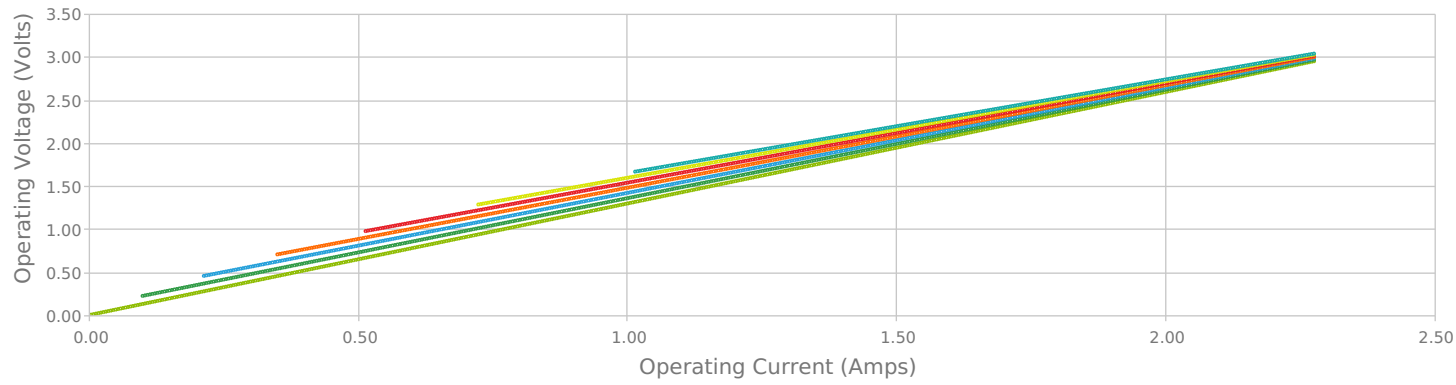
Heat Pumped at Cold Side
 $T_{hot} = 27\text{ °C}$



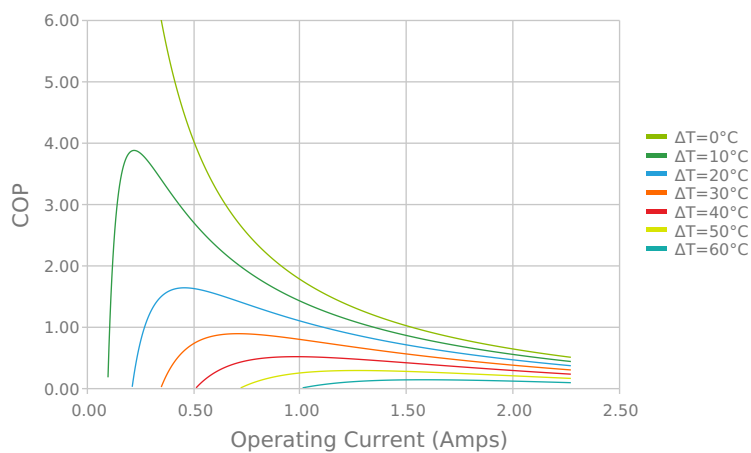
Heat Pumped at Cold Side
 $T_{hot} = 27\text{ °C}$



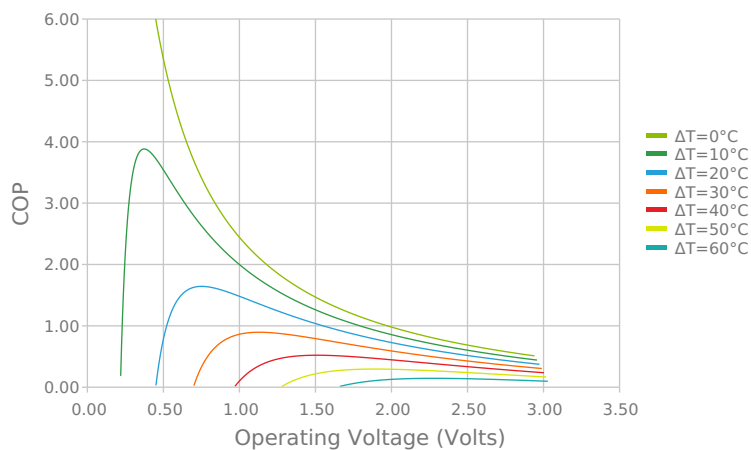
Current vs Voltage (I vs V)
Thot = 27 °C



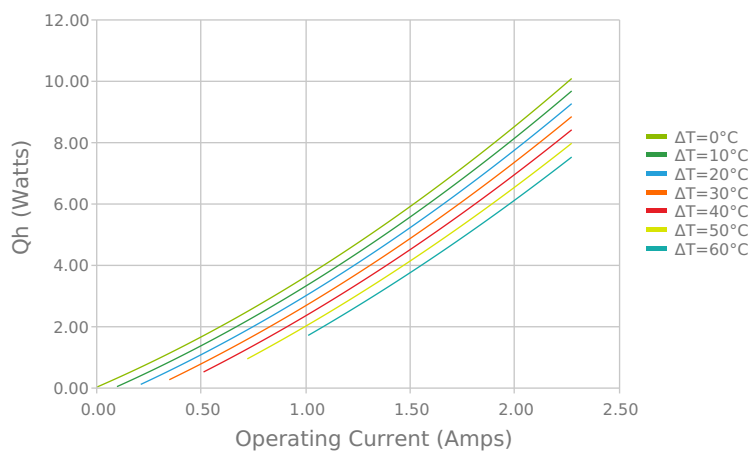
Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 27\text{ }^{\circ}\text{C}$



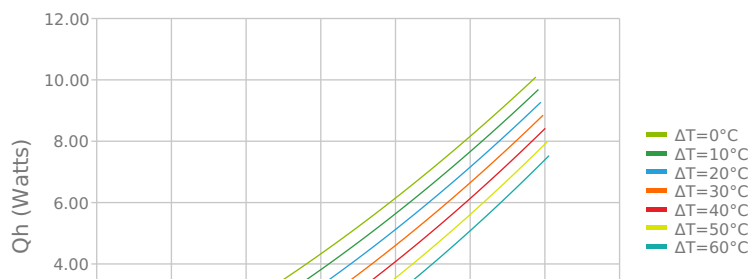
Coefficient of Performance (COP = Q_c/P_{in})
 $T_{hot} = 27\text{ }^{\circ}\text{C}$



Total Heat Dissipated at Hot Side ($Q_h=Q_c+P_{in}$)
 $T_{hot} = 27\text{ }^{\circ}\text{C}$



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 $T_{hot} = 27\text{ }^{\circ}\text{C}$



SPECIFICATIONS*

Hot Side Temperature

Qcmax ($\Delta T = 0$)

ΔT_{max} ($Q_c = 0$)

I_{max} (I @ ΔT_{max})

V_{max} (V @ ΔT_{max})

Module Resistance

Max Operating Temperature

Weight

27.0 °C

50.0 °C

80.0 °C

3.4 Watts	3.6 Watts	3.9 Watts
72.9°C	81.8°C	92.1°C
2.0 Amps	2.0 Amps	1.9 Amps
2.8 Volts	3.1 Volts	3.5 Volts
1.29 Ohms	1.46 Ohms	1.67 Ohms
120 °C		
1.0 gram(s)		

* Specifications reflect thermoelectric coefficients updated March 2020

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
GG	2.514 ±0.127 mm 0.099 ± 0.0050 in	N/A / N/A	Au Plated	Au Plated	50.8 mm 2.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
	None			No sealing specified

NOTES

1. Max operating temperature: 120°C
2. Do not exceed I_{max} or V_{max} when operating module
3. Reference assembly guidelines for recommended installation
4. Solder tinning also available on metallized ceramics

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